

INFORMATION DISCLOSURE CITATION IN AN APPLICATION <small>(Use several sheets if necessary)</small>				Docket Number (Optional) MSCLIN98-281		Application Number 09/131,429	
				Applicant M.S. Lin		Filing Date 08/10/98	
						Group Art Unit 2811	
U. S. PATENT DOCUMENTS							
	EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)							
<i>nf</i>	M. Hou, "Wafer level packaging for CSPs" Semiconductor International, July 1998, p 305-308						
EXAMINER <i>HP, APR/98</i>				DATE CONSIDERED <i>12/4/99</i>			
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant							

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